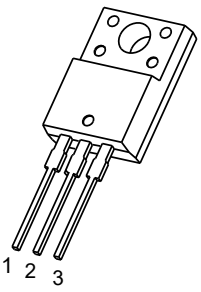
SZCJ Shenzhen Changji Semiconductor Co., LTD.

TO-220F-B Plastic-Encapsulate MOSFETS

CJPF10N50M1 N-Channel Power MOSFET

$V_{(BR)DSS}$	$R_{DS(on)}$TYP	I_D
500V	0.41Ω@10V	10A

TO-220F-B



1. GATE
2. DRAIN
3. SOURCE

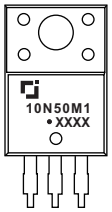
GENERAL DESCRIPTION

This advanced high voltage MOSFET is designed to stand high energy in the avalanche mode and switch efficiently. This new high energy device also offers a drain-to-source diode fast recovery time.Designed for high voltage, high speed switching applications such as power supplies, converters, power motor controls and bridge circuits.

FEATURE

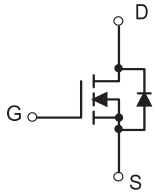
- High Current Rating
- Low Gate Charge
- Lower $R_{DS(on)}$
- Low Reverse Transfer Capacitance
- Fast Switching Capability
- Tighter V_{SD} Specifications
- Avalanche Energy Specified

MARKING



10N50M1= Device code.
Solid dot = Green molding compound device, if none, the normal device
XXXX = Code

EQUIVALENT CIRCUIT



MAXIMUM RATINGS (T_J=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	500	V
Gate-Source Voltage	V_{GS}	±30	V
Continuous Drain Current	I_D ①	10	A
Pulsed Drain Current	I_{DM} ①②	40	A
Single Pulsed Avalanche Energy	E_{AS} ③	454	mJ
Power Dissipation	P_D ①	83	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$ ⑥	48	℃/W
Thermal Resistance from Junction to Case	$R_{\theta JC}$ ①	1.5	℃/W
Operating Junction and Storage Temperature Range	T_J ,T_{stg}	-55~+150	℃

MOSFET ELECTRICAL CHARACTERISTICS

T_J=25℃ unless otherwise specified

Parameter	Symbol	Test Condition		Min	Typ	Max	Unit
Off characteristics							
Drain-source breakdown voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D =1mA		500			V
Zero gate voltage drain current	I_{DSS}	V_{DS}=500V, V_{GS}=0V	T_J=25℃			1.0	μA
			T_J=125℃			100	
Gate-body leakage current	I_{GSS}	V_{DS} =0V, V_{GS} =±30V				±100	nA
On characteristics④							
Gate-threshold voltage	$V_{GS(th)}$	V_{DS} =V_{GS}, I_D =250μA		2.0	3.0	4.0	V
Static drain-source on-resistance	$R_{DS(on)}$	V_{GS} =10V, I_D =5A			0.41	0.68	Ω
Dynamic characteristics ⑤							
Input capacitance	C_{iss}	V_{DD}=50V,f =1MHz			1727		pF
Output capacitance	C_{oss}				148		
Reverse transfer capacitance	C_{rss}				27		
Gate resistance	R_g	f =1MHz			2.9		Ω
Switching characteristics ⑤							
Total gate charge	Q_g	V_{DS} =50V,V_{GS} =10V,I_D =10A			25		nC
Gate-source charge	Q_{gs}				7		
Gate-drain charge	Q_{gd}				5		
Turn-on delay time	$t_{d(on)}$	V_{DD}=50V, V_{GS}=10V, R_g=10Ω, I_D =10A			4		ns
Turn-on rise time	t_r				25		
Turn-off delay time	$t_{d(off)}$				12		
Turn-off fall time	t_f				16		
Drain-Source Diode Characteristics							
Drain-source diode forward voltage	V_{SD}④	V_{GS} =0V,I_S =10A				1.2	V
Maximum continuous drain-source diode forward current	I_S①					10	A
Maximum pulsed drain-source diode forward current	I_{SM}①②					40	A
Reverse recovery time	trr	dIF/dt = 100A/μs, I_S = 10A, V_{DD} = 50V			249		ns
Reverse recovery charge	Qrr				2343		nC

Notes :

1.T_C=25℃ Limited only by maximum temperature allowed.

2.P_W≤10μs, Duty cycle≤1%.

3.EAS condition: VDD=50V,VGS=10V, L=10mH, Rg=25Ω Starting T_J = 25℃.

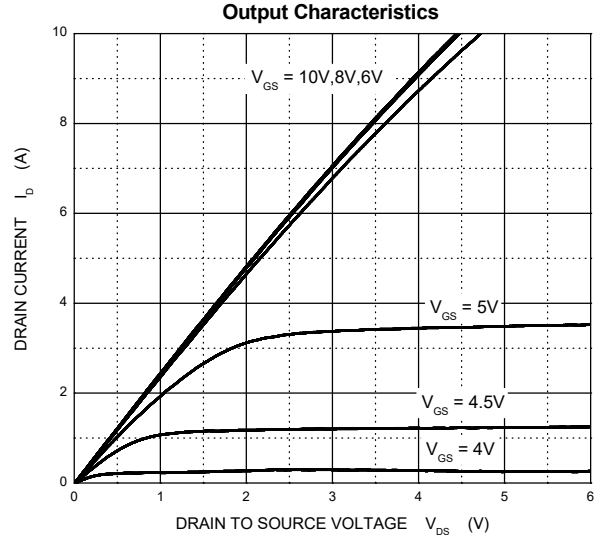
4.Pulse Test : Pulse Width≤300μs, duty cycle ≤2%.

5.Guaranteed by design, not subject to production.

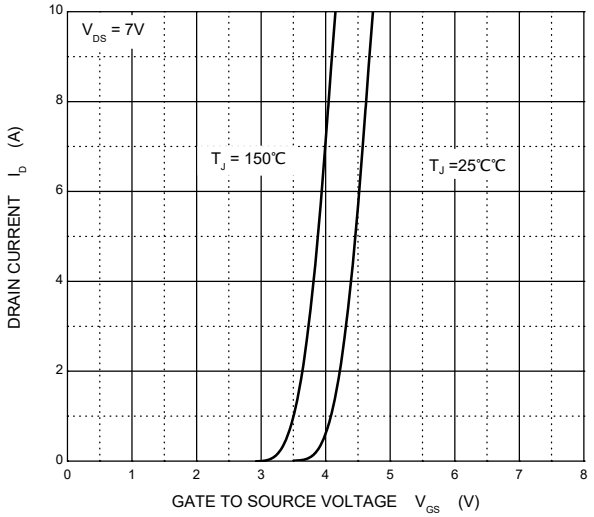
6.The value of $R_{\theta JA}$ is measured with the device in a still air environment with T_a=25℃.

Typical Characteristics (T_J = 25℃, unless otherwise specified)

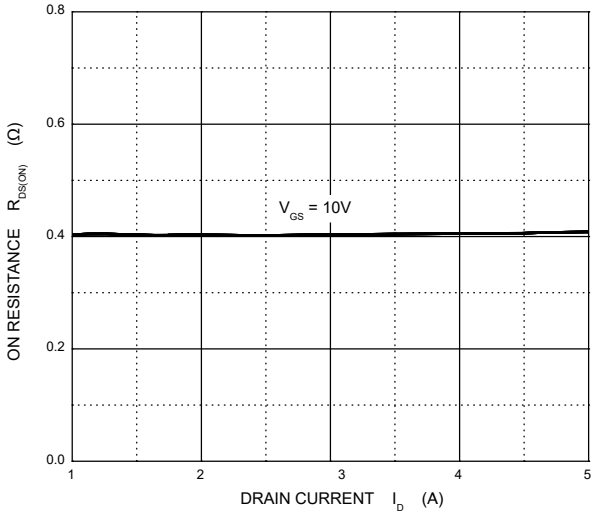
Output Characteristics



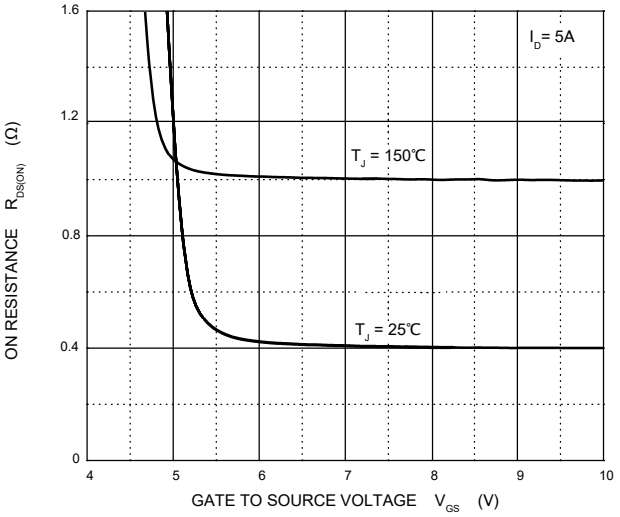
Transfer Characteristics



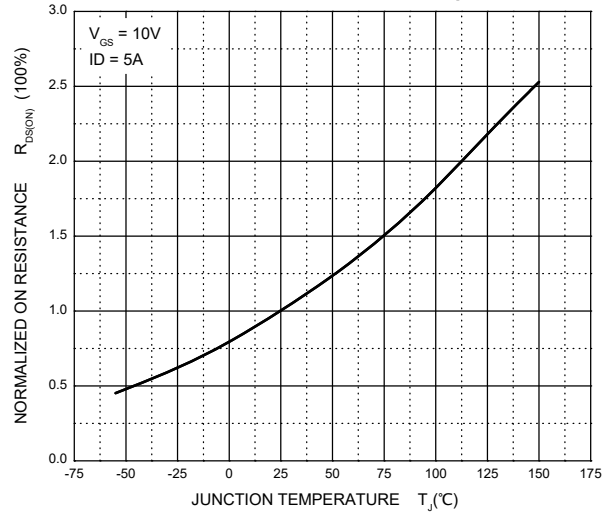
On Resistance vs. Drain Current



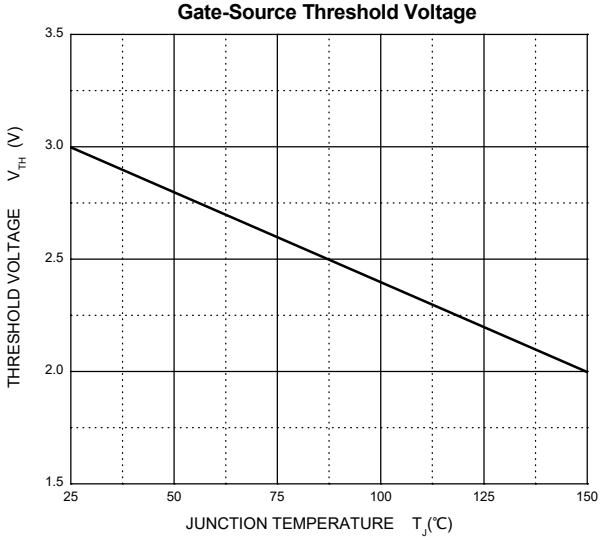
On Resistance vs. Gate-Source Bias



On Resistance vs. Junction Temperature

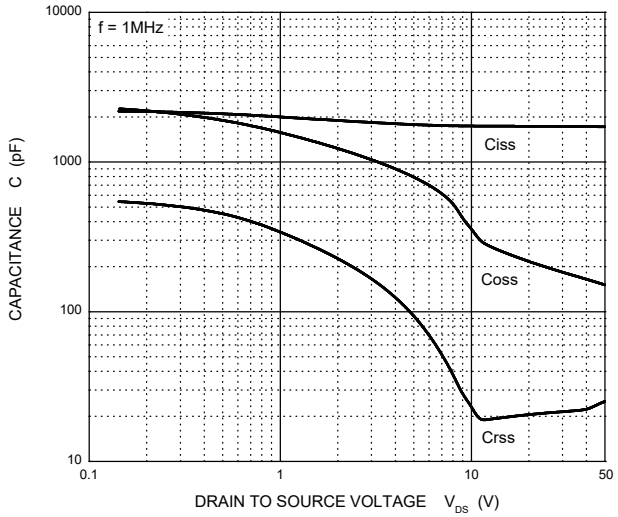


Gate-Source Threshold Voltage

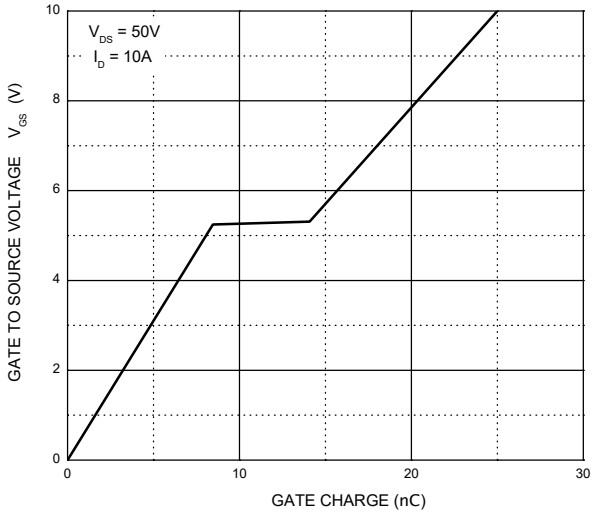


Typical Characteristics (T_J = 25℃, unless otherwise specified)

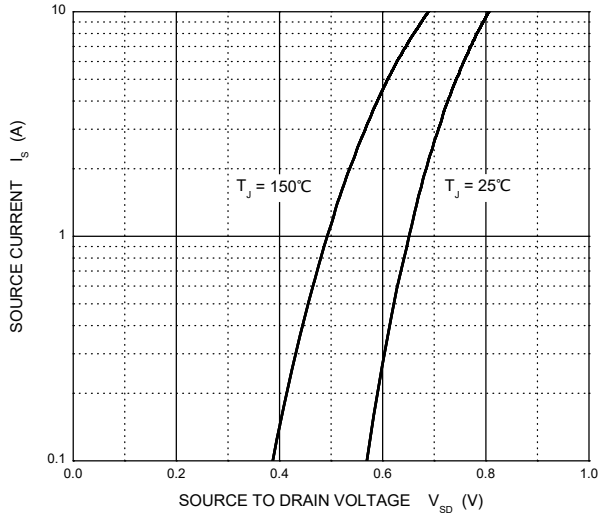
Typical Capacitances



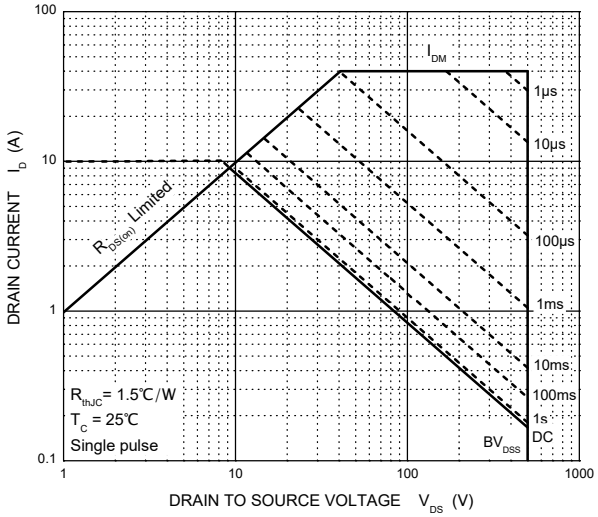
Gate Charge



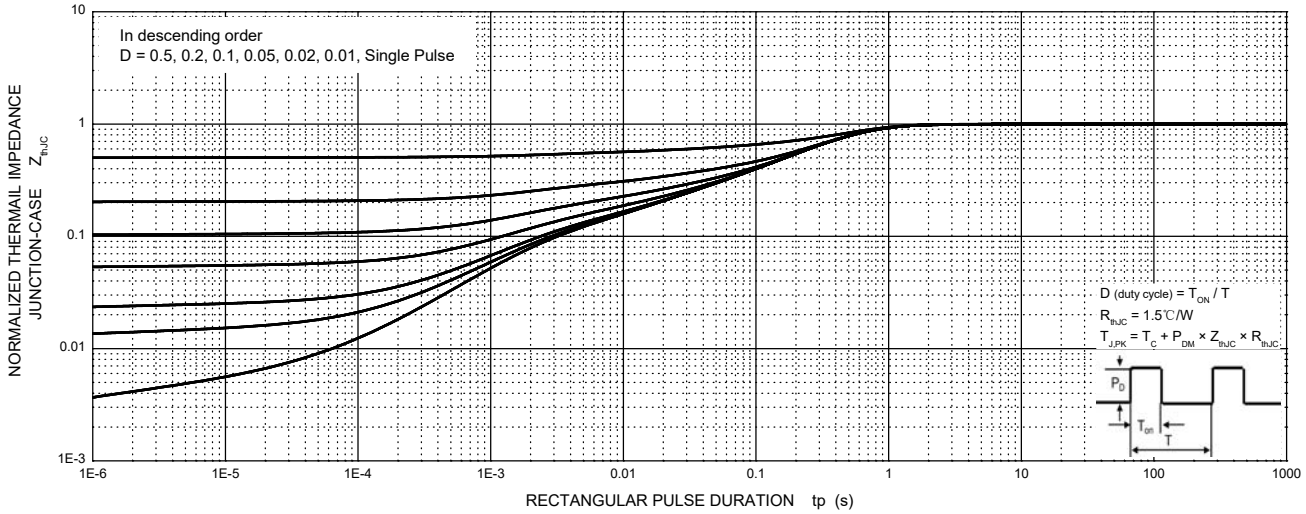
Source-Drain Diode Forward Characteristics



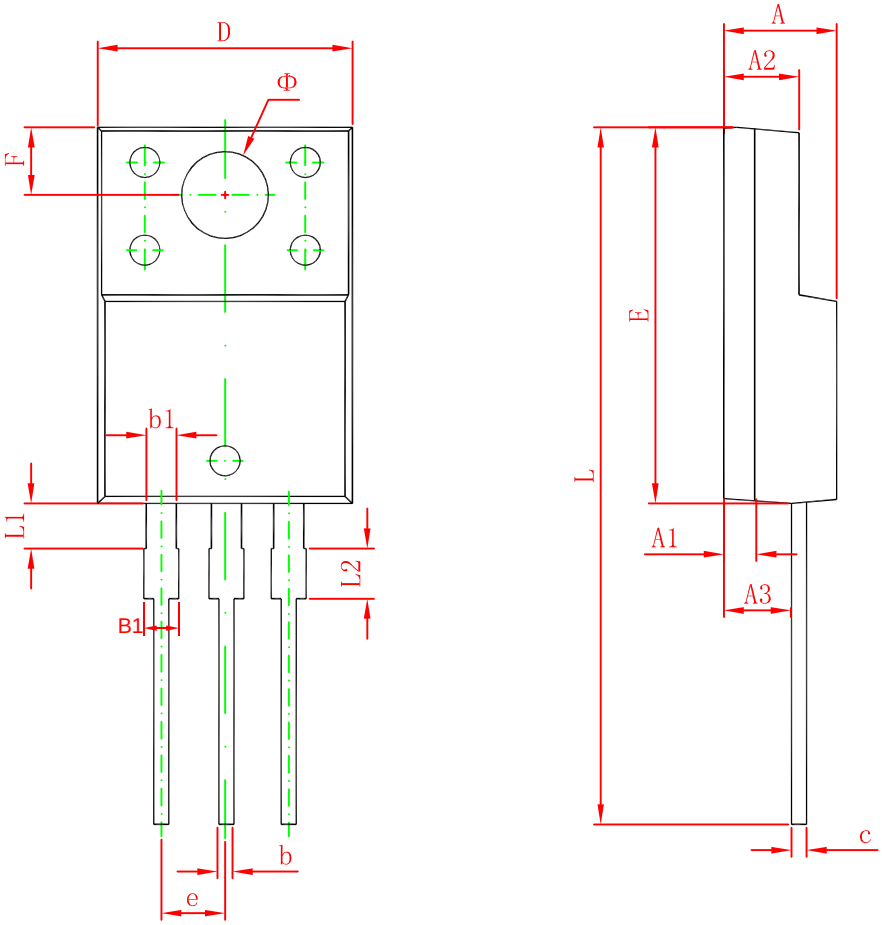
Maximum Safe Operating Area



Transient Thermal Impedance, Junction-Case



TO-220F-B Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.300	4.700	0.169	0.185
A1	1.200 REF.		0.047 REF.	
A2	2.800	3.200	0.110	0.126
A3	2.500	2.900	0.098	0.114
b	0.710	0.910	0.028	0.036
b1	1.100	1.350	0.043	0.053
B1	1.150	1.400	0.045	0.055
c	0.500	0.750	0.020	0.030
D	9.960	10.360	0.392	0.408
E	14.800	15.200	0.583	0.598
e	2.540 TYP.		0.100 TYP.	
F	2.700 REF.		0.106 REF.	
Φ	3.300	3.700	0.130	0.146
L	28.000	28.400	1.102	1.118
L1	2.100	2.400	0.082	0.094
L2	1.300	1.700	0.051	0.066